

#### 3.0x2.5mm SURFACE MOUNT LED LAMP



**ATTENTION** 

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

Part Number: KPB-3025QBDSYKC

Blue

Super Bright Yellow

#### **Features**

- 3.0mmx2.5mm SMT LED, 1.1mm thickness.
- Bi-color,Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

The Blue source color devices are made with InGaN Light Emitting Diode.

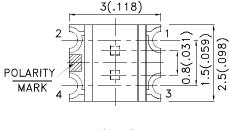
The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

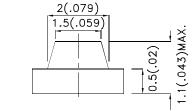
Static electricity and surge damage the LEDS.

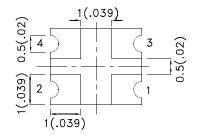
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

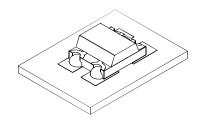
### **Package Dimensions**







$$\begin{array}{c} \text{SYK} \\ \text{4} & \longleftarrow \swarrow \longrightarrow 3 \end{array}$$



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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DRAWN: Y.Liu

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#### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPB-3025QBDSYKC	Blue (InGaN)	Water Clear	55	80	120°
	Super Bright Yellow (AlGaInP)	Water Clear	80	120	

#### Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
   2. Luminous intensity/ luminous Flux: +/-15%.
   3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Blue Super Bright Yellow	460 590		nm	IF=20mA	
λD [1]	Dominant Wavelength	Blue Super Bright Yellow	465 590		nm	IF=20mA	
Δλ1/2	Spectral Line Half-width	Blue Super Bright Yellow	25 20		nm	IF=20mA	
С	Capacitance	Blue Super Bright Yellow	100 20		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Blue Super Bright Yellow	3.3 2	4 2.5	V	IF=20mA	
lr	Reverse Current	Blue Super Bright Yellow		50 10	uA	V <sub>R</sub> = 5V	

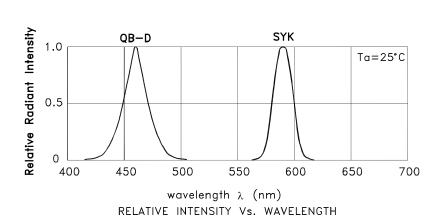
- NWavelength: +/-1nm.
   Forward Voltage: +/-0.1V.
   Wavelength value is traceable to the CIE127-2007 compliant national standards.

### Absolute Maximum Ratings at TA=25°C

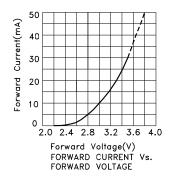
Parameter	Blue	Super Bright Yellow	Units		
Power dissipation	120	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	150	175	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

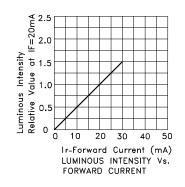
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

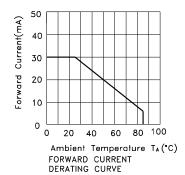
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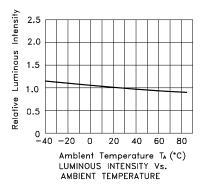


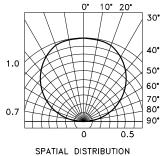
#### KPB-3025QBDSYKC Blue







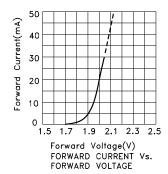


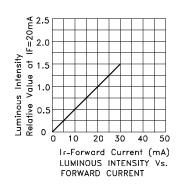


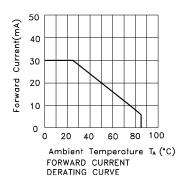
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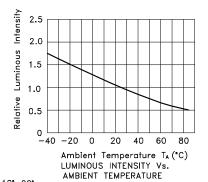
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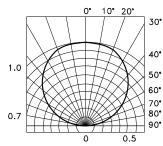
### **Super Bright Yellow**











SPATIAL DISTRIBUTION

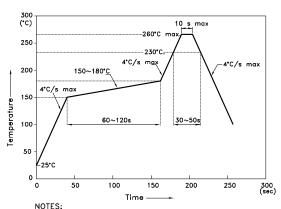
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#### **KPB-3025QBDSYKC**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

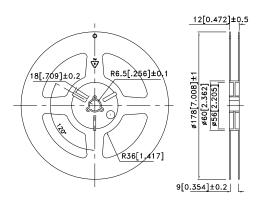
  3.Number of reflow process shall be 2 times or less.

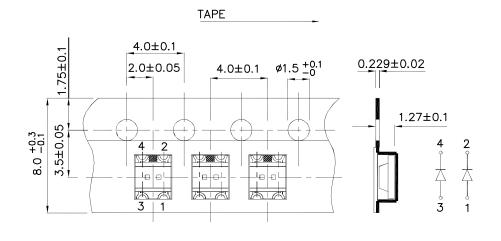
### **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

# 4.4 0.6 L- 1.0

### **Tape Dimensions** (Units: mm)

#### **Reel Dimension**

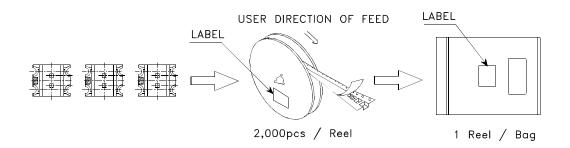


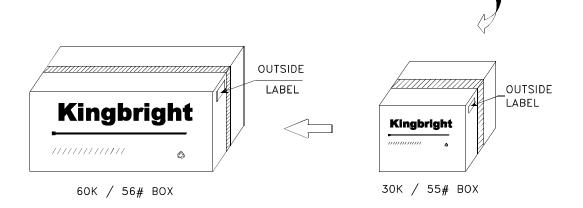


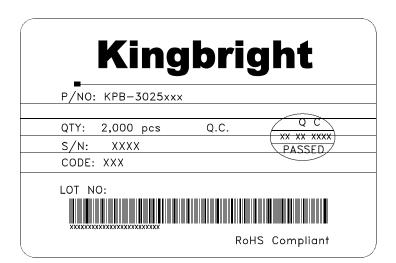
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#### **PACKING & LABEL SPECIFICATIONS**

#### **KPB-3025QBDSYKC**







Detailed application notes are listed on our website. <a href="http://www.kingbright.com/application">http://www.kingbright.com/application</a> notes

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